



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

PATENT

IN RE APPLICATION OF: WHONCHEE LEE ET AL.
 APPLICATION No.: 09/888,084
 FILED: JUNE 21, 2001
 FOR: METHODS AND APPARATUS FOR
 ELECTRICAL, MECHANICAL AND/OR
 CHEMICAL REMOVAL OF
 CONDUCTIVE MATERIAL FROM A
 MICROELECTRONIC SUBSTRATE

EXAMINER: DUNG V. NGUYEN
 ART UNIT: 3723
 CONF. No: 8101

146C
 amlt
 10-8-03

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 SEP 17 2003

Amendment Under 37 C.F.R. § 1.111

TECHNOLOGY CENTER 18700

Commissioner for Patents
 P.O. Box 1450
 Alexandria, VA 22313-1450

Sir:

The present communication responds to the Office Action dated June 13, 2003 in the above-identified application. Please amend the application as follows:

Amendments to the Claims are reflected in the listing of claims beginning on page 2.

09/16/2003 BSAYASI1 00000134 09888084

01 FC:1201 252.00 OP

10/09/2003 NCHAPMAN 00000002 500665 09888084

01 FC:1202 90.00 DA
02 FC:1201 168.00 DA